



- **TECHNICAL DATA**

- **PCB**
  - max. placement area 540 x 480mm
- **Components range**
  - from 0201 up to 40 x 80mm
  - min. pitch 0,4mm
- **Components packing**
  - tapes / sticks / trays / bulk
- **Components centering**
  - non-contact alignment
- **Placement rate**
  - up to 1600 cph
- **Feeder capacity**
  - up to 33 x 8mm automatic tape feeder and 40X8mm semi tape feeder
  - and 2 x (300 x 200mm) - IC-tray with 200 x 300mm PCB size
- **Resolution**
  - X / Y- axis – 0,008mm – linear encoder
  - Z – axis – 0,020mm – linear encoder
- **Placement accuracy**
  - +/- 0,03 mm
- **Dimension and weight**
  - 840 x 700 x 430 mm / ca. 95 kg
- **Supply**
  - 110-230V /50-60Hz /1150W /6 Mpa / 25 l/min

- **KEY FEATURES**

- **automatic SMT pick and place machine**
- **1 x automatic pick & place head**
- **automatic nozzle changer (6 tools )**
- **top camera - system for automatic fiducial**
- **bottom camera - optical alignment system for SMD components**
- **CAD – editor for pick & place files**
- **teach-in mode**
- **image processing system**
- **smart feeder system – CAN Bus**
- **operating system: Windows 10**
- **control panel: PC keyboard / mouse**
- **user interface - PC and LCD monitor**
- **application range**
  - prototypes and low volume production
  - qualified for pick & place of all types of SMD components